Novel Microfluidic Valving and Packaging Designs for Protein Containing Biochips

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Lab-on-a-Chip







O.R.C.A microFluids (Micronics, Inc.)



NanoChipTM (Nanogen, Inc.)

LabCardTM (ACLARA BioSciences, Inc.)

Microtiterplate Lilliput (STEAG microParts GmbH)



LabChip[®] (Caliper, Inc.)

- •Point of care -- fast response
- •Small amount of sample $< \mu l$
- •Parallel detection
- •Information storage

Lab-on-a-Chip



ELISA

- Enzyme-linked Immuno-Sorbent Assay
 - Bioassays in life sciences research
 - Food Safety detection of foodborne pathogens and toxins
 - Biodiagnostics detection of cancer and immuno diseases
 - Environmental pollutants
 - National security detection of bio- and chemi-warfare agents

\$5-10B/yr. ELISA market for cancer, HIV, food and water detection!

Schematic of ELISA



Conventional 96-well ELISA



- Time consuming (hours to 2~3 days) Immunoreaction is diffusion controlled Long incubation time (several hours)
- Relatively large reagent consumption (several hundred µl)
- Labor intensive
- Inconsistent results



CD Microfluidic Platform System



Pumping and Valving

Driving Force

☆ Centrifugal force

Capillary Valve



Pumping and Valving - Flow Sequencing



Chamber index:

1- Calibration 1; 2- Wash 1; 3- Calibration 2;4- Wash 2; 5- Sample

M. J. Madou, L.J. Lee, S. Daunert, K. W. Koelling, S. Lai, C-H Shih, *Biomedical Microdevices*, 2001

Flow Sequencing



Displacement in Optode



CD-ELISA Chip Design



Issues

- Design: dimension control; aspect ratio; multiple depth; many reservoirs
- Protein blocking: Valving
- Protein preloading: Bonding

CD Manufacturing



Design Issues

layer

- Higher aspect ratio desirable
- Multiple depth is needed • for a larger design window for 9-reservoir CD and bubble free sample loading
- Mold fabrication is more • difficult
- Mold release





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- Flow sequence: dimension; aspect ratio; multiple depth, more reservoirs
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Protein Issues in Capillary Valving

- Surface property changes after protein blocking
- The valving capacity
 lost or reduced





w/o protein blocking



with protein blocking

Principle of Super-hydrophobicity

□Wensel's theory

$$\cos\theta = r(\gamma_{sv} - \gamma_{sl}) / \gamma_{lv} \quad (1)$$



Plasma Treated and Surface Microstructured PMMA

Typical PMMA $\theta \sim 73^{\circ}$



□Fluorine plasma (CHF3) treated PMMA surface $\theta \sim 108^{\circ}$

□Fluorine plasma treated micro-patterned PMMA surface $\theta > 160^{\circ}$, f=0.1







Effect of Protein Blocking on Contact Angle



Fishbone Design Based on Superhydrophobicity



Fishbone design

Advantages:

Protein solution

 Protein-proof with superhydrophobic property

•Easy fabrication (embossing or injection molding)

•Easy alignment of bonding



Blocking Process Simulation (Flow-3D[®]) and Visualization









Hydrophilic

PMMA surface w/o plasma treatment









Hydrophobic surface with plasma treatment









calculated burst frequency



Top and bottom view

Holding pressure test



Experimental vs. theoretical Burst frequency

- Single channel -Syringe injection plus vacuum removal
- CD device -Centrifugal force
- Why discrepant?
 - -bonding defect-local defect-loading defect

Parameter	Valve 1	Valve 2	Valve3	Valve4	Valve5
Protein Treatment Type	0.1 wt% BSA soak	0.1 wt% BSA soak	0.1 wt% BSA soak	0.1 wt% BSA soak	0.1 wt% BSA soak
R1 (mm)	23.3	21.6	32.5	39.0	25.5
R2 (mm)	27.0	27.2	39.0	44.5	31.1
R_delta	3.7	5.6	6.5	5.5	5.6
Width	200	200	200	200	200
Depth(mm)	100	100	100	100	100
(mN/m)	72.9	72.9	72.9	72.9	72.9
Density	1.0	1.0	1.0	1.0	1.0
Burst Freq.	768	634	486	489	589
Exp. Burst Freq	761	705	478	541	573
Match?	YES	NO	YES	NO	YES

Issues

- Flow sequence: dimension; aspect ratio; multiple depth; more reservoirs
- Protein issues: Valving
- Protein preloading: Bonding

Platform Bonding Methods

Silicon/Glass/Metal Materials:

- Anodic bonding
- Fusion bonding
- Eutectic bonding
- Adhesive bonding
- Well developed in IC industry
 Usually high temperature, high voltage, or high pressure
- **X** most not applicable to polymers

Polymeric Materials:

- Welding (hot plate, laser, ultrasound)
- Lamination (adhesive tape, film thermal bonding)
- Chemical (solvent) bonding
- ✓ Well developed in polymer industry
- Applicable mainly to relatively large features (several hundred microns)

Typical dimensions in BioNEMS/MEMS applications: 10 nm \sim 100 μm

Surface T_g of PS under CO₂



Y. Yang, L.J. Lee

CO₂ Bonding Experimental Setup



CO2 bonding (200psi, 75psi, 1 hour)

CO₂ Bonding and Testing Results





CO2 bonding (200psi, 75psi, 1 hour, PLGA interlayer)

Thermal lamination: 140°C, 10sec

Collaboration with Ritek and Tecan

BioLOC/OSU

- Microfluidics design
- Surface modification
- Reagent loading
- Packaging

RITEK

CD manufacturing

Tecan

- Reader (detection/equipment)
- Software development